

FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High surge capability
- High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2011/65/EU

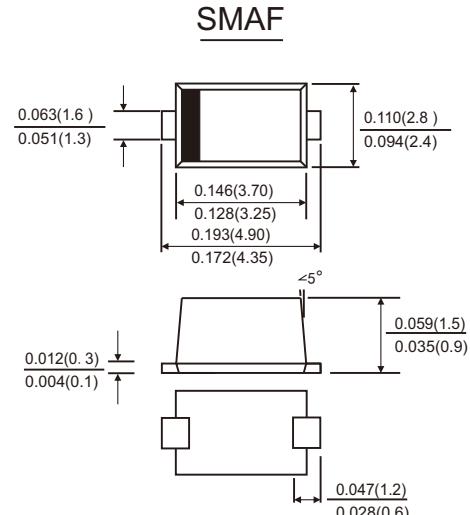


MECHANICAL DATA

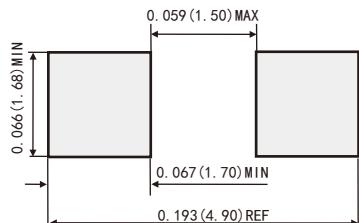
Case: SMAF molded plastic body

Terminals: Solder Plated, solderable per MIL-STD-750,method 2026

Polarity: Color band denotes cathode end



Suggested PAD Layout



Dimensions in inches and (millimetres)

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|--|-----------------------------|-------------|------|
| Maximum repetitive peak reverse voltage | V _{R_{RM}} | 200 | V |
| Maximum average forward rectified current (see fig.1) | I _{F(AV)} | 5.0 | A |
| Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method) | I _{F_{SM}} | 120 | A |
| Operating junction temperature range | T _J | -55 to +150 | °C |
| Storage temperature range | T _{sg} | -55 to +150 | °C |

RATINGS AND CHARACTERISTICS OF SS520LS

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ Unless otherwise noted)

| Parameter | Test Conditions | | Symbol | TYP. | MAX. | Unit |
|-------------------------------|-------------------|-------------------------|---------------------|------|------|---------------|
| Instantaneous forward voltage | $I_F=5.0\text{A}$ | $T_A=25^\circ\text{C}$ | V_F ¹⁾ | 0.81 | 0.90 | V |
| | | $T_A=100^\circ\text{C}$ | | 0.69 | — | |
| | | $T_A=125^\circ\text{C}$ | | 0.66 | — | |
| | $I_F=2.0\text{A}$ | $T_A=25^\circ\text{C}$ | | 0.74 | — | |
| | | $T_A=100^\circ\text{C}$ | | 0.63 | — | |
| | | $T_A=125^\circ\text{C}$ | | 0.59 | — | |
| | $V_R=200\text{V}$ | $T_A=25^\circ\text{C}$ | | 5 | 20 | μA |
| | | $T_A=100^\circ\text{C}$ | | — | 1.0 | mA |
| | | $T_A=125^\circ\text{C}$ | | — | 3.0 | |
| Typical junction capacitance | 4V, 1MHz | | C_J | 100 | | pF |

Notes: 1.Pulse test: 300 μs pulse width, 1% duty cycle

2.Pulse test: pulse width $\leqslant 40\text{ms}$

THERMAL CHARACTERISTICS

| Parameter | Symbol | SMAF | Unit |
|--|-----------------|------|--------------------|
| Typical thermal resistance ³⁾ | $R_{\theta JA}$ | 150 | $^\circ\text{C/W}$ |
| | $R_{\theta JL}$ | 28 | |

3.P.C.B. mounted with 0.118" x 0.118" (3.0 mm x 3.0 mm) copper pad areas ($\geq 40\mu\text{m}$ thick)

AVAILABALE PACK INFORMATION

| Product code | Pack | Reel Size (mm) | Quantity (pcs/reel) | Box Size L×W×H (mm) | Quantity (reel/box) | Carton Size L×W×H (mm) | Quantity (box/carton) |
|--------------|------|----------------|---------------------|---------------------|---------------------|------------------------|-----------------------|
| SS520LS-SMAF | T/R | Φ178 | 3000 | 180×73×180 | 2 | 380×380×200 | 10 |

RATINGS AND CHARACTERISTICS OF SS520LS

FIG.1-FORWARD CURRENT DERATING CURVE

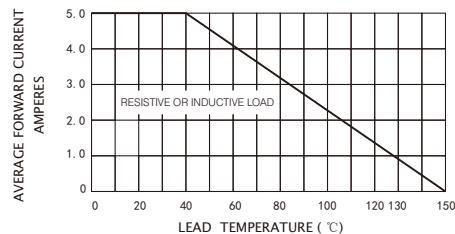


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

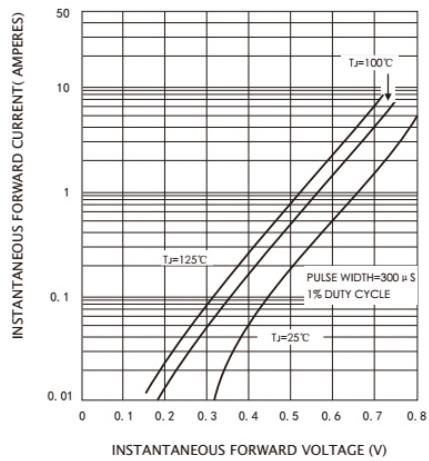


FIG.5-TYPICAL JUNCTION CAPACITANCE

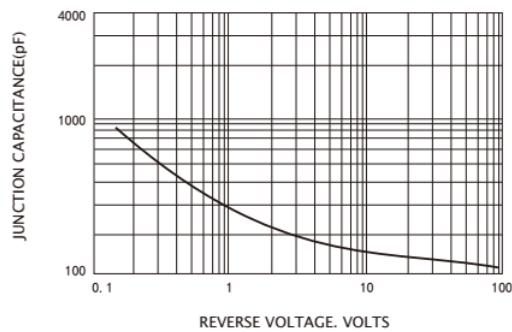


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

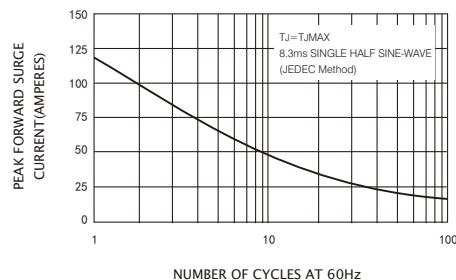


FIG.4-TYPICAL REVERSE CHARACTERISTICS

